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U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE -

APPL NUM 10033546	FILING DATE 12/27/2001	CLASS 257	SUBCLASS 784	GAU 281	EXAMINER KOREKH
**APPLICANTS: Lin Fong-Long; Briner Michael;					
**CONTINUING DATA VERIFIED:					
** FOREIGN APPLICATIONS VERIFIED:					
PG-PUB <input type="checkbox"/> DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no Verified and Acknowledged Examiners's initials				ATTORNEY DOCKET NO 2102397-992070	
TITLE : Bond out chip and method for making same					

U.S. DEPT. OF COMM./PAT. & TM.-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		Assistant Examiner		CLAIMS ALLOWED	
C				Total Claims	Print Claim for O.G.
ISSUE FEE		Primary Examiner		DRAWING.	
Amount Due	Date Paid			Sheets Drwg.	Figs. Drwg.
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE		Application Examiner	
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